

Electronics | OptoElectronics

Data Sheet

RPOpto-Clamp SI-PIN Photo diode

SI-PIN Photo Diode 400..1100nm

General

The RPOpto-Clamp is especially suitable for applications with standard 1mm plastic fiber optical cable. Pre-mounted with a high speed Si PIN photodiode the device is designed for visible to near infrared light detection with wideband characteristics at low bias, making it suitable for optical communications and other photometry. The RPOpto-Clamp is a good solution in data transmission systems with plastic fiber optical cable.

2 Applications _____

Due to the high speed, the good optical and mechanical features, this receiver may be used in many applications:

- Optical networks
- Industrial electronic
- Power electronic



Pic. 1 Fiber optic receiver

Features _

- 400..1100nm PIN photodiode
- High sensitivity
- t_i , $t_i \le 5$ ns
- Suitable for all plastic optical fiber cables with an outside diameter of 2.2 mm and a fiber diameter of 1 mm
- Fast locking mechanism (manual control)
- Plastic housing
- Suitable for automatic assembly
- Reflow-/ wave soldering

3 Ordering Information _

Style

Part Number

Photo diode Photo diode (with front panel fill)

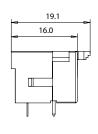
905EMPINKR003 905EMPINKR004

Technical Drawing

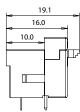
Housing

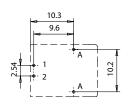


without front panel fill



with front panel fill





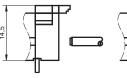
Drill drawing for PCB

View: Component side Drill diameter: PIN 1,2

Fixing pins A

 $= 0.8 \, \text{mm}$ = 1 mm

positions of sliders, locking mechanism





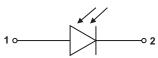


Fiber fixed by clamping.



In this position the RPopto clamp connector is dust and light protected.

Schematic diagram



Pic 2 Case drawing



SI-PIN Photo Diode 400..1100nm

6 Maximum Ratings (T_A=25°C) _____

Stresses beyond those listed under 'Maximum Ratings' may cause permanent damage to the device. Listed values are stress limits only and functional operation of the device at these conditions is not recommended. Exposure to maximum rating conditions for extended periods may affect the device reliability.

Parameter	Value	Unit		
Operating temperature	-40 +100	°C		
Storage temperature	-4 0 +100	C		
Soldering temperature: 1.) 2mm from case, t ≤ 10s; 2.) max. 10s at max. 5s contact time per wave	260	°C		
Reverse voltage	20	V		
	50 at t ≤ 2min	V		
Power dissipation	150	mW		
ESD withstand voltage	2	kV		

7 Technical Data (T_A=25°C) _____

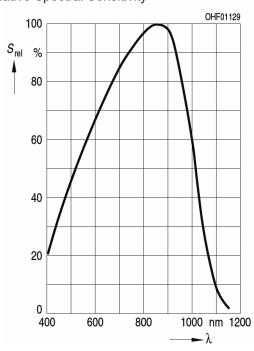
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Spectral range of sensitivity	λ _{10%}		400		1100	nm
Wavelength of max sensitivity	$\lambda_{_{Smax}}$			850		nm
Half angle	φ			75		°deg.
Dark current	I _R	V _R =20V		1	5	nA
Spectral sensitivity of the chip	S _A	λ=850nm		0.62		A/W
Open-circuit voltage	V _o	E _v =1000lx; Std. Light A	300	350		mV
Short-circuit current	I _{sc}	E _v =1000lx; Std. Light A		9.3		μΑ
Rise and fall time	t _r	VR = 20 V; RL = 50 Ω; λ = 850 nm		0.005		· µs
	t _f					
Forward voltage	V_{F}	IF = 100 mA; E = 0		1.3		V
Capacitance	C _o	VR = 0 V; f = 1 MHz; E = 0		11		pF
Temperature coefficient	TC _v	Voltage		-2.6		mV/K
	TC,	Short-circuit current Std. Light A		0.18		%/K



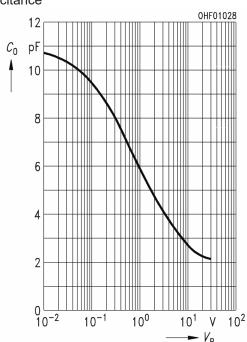
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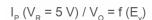
8 Characteristics

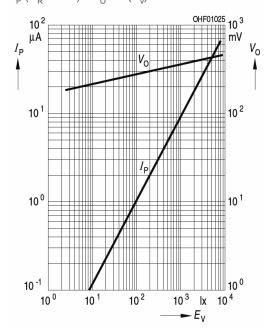
Relative Spectral Sensitivity



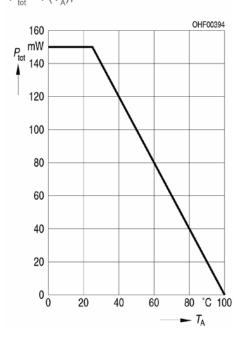
Capacitance







$$P_{tot} = f(T_A);$$



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